

N-channel TrenchMOS standard level FET Rev. 04 — 7 April 2010

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using Nexperia High-Performance Automotive (HPA) TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

- Q101 compliant
- Suitable for standard level gate drive sources

1.3 Applications

- 12 V and 24 V loads
- Advanced braking systems (ABS)
- Automotive systems

1.4 Quick reference data

- Suitable for thermally demanding environments due to 175 °C rating
- Engine management
- General purpose power switching
- Motors, lamps and solenoids

| Table 1. | Quick reference da | ta | | | | |
|----------------------|--|--|-----|------|------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | - | - | 55 | V |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u> ; see <u>Figure 4</u> | - | - | 47.4 | Α |
| P _{tot} | total power dissipation | $T_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{2}$ | - | - | 85 | W |
| Static cha | aracteristics | | | | | |
| R _{DSon} | drain-source on-state resistance | $\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 20 \text{ A}; \\ T_{j} = 25 \text{ °C}; \text{ see } \underline{\text{Figure 12}}; \\ \text{see } \underline{\text{Figure 13}} \end{array}$ | - | 12.7 | 18 | mΩ |
| Avalanch | e ruggedness | | | | | |
| E _{DS(AL)S} | non-repetitive drain-source avalanche energy | $ \begin{split} I_D &= 47.4 \text{ A}; \text{V}_{\text{sup}} \leq 55 \text{ V}; \\ R_{\text{GS}} &= 50 \Omega; \text{V}_{\text{GS}} = 10 \text{V}; \\ T_{j(\text{init})} &= 25 ^{\circ}\text{C}; \text{ unclamped} \end{split} $ | - | - | 77 | mJ |
| Dynamic | characteristics | | | | | |
| Q_{GD} | gate-drain charge | I _D = 20 A; V _{DS} = 44 V; V _{GS} = 10 V; see Figure 14 | - | 8.1 | - | nC |

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2. Pinning information

| Table 2. | Pinning | information | | |
|----------|---------|-----------------------------------|---|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | S | source | | _ |
| 2 | S | source | mb () | |
| 3 | S | source | | |
| 4 | G | gate | ٩ | |
| mb | D | mounting base; connected to drain | $\begin{array}{c} & & \\ & & \\ & \\ 1 & 2 & 3 & 4 \end{array}$ | mbb076 S |
| | | | SOT669 (LFPAK) | |

3. Ordering information

| Table 3. | Ordering in | formation | | |
|---------------------|-------------|-----------|---|---------|
| Type number Package | | Package | | |
| | | Name | Description | Version |
| BUK7Y18- | 55B | LFPAK | plastic single-ended surface-mounted package (LFPAK); 4 leads | SOT669 |

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4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

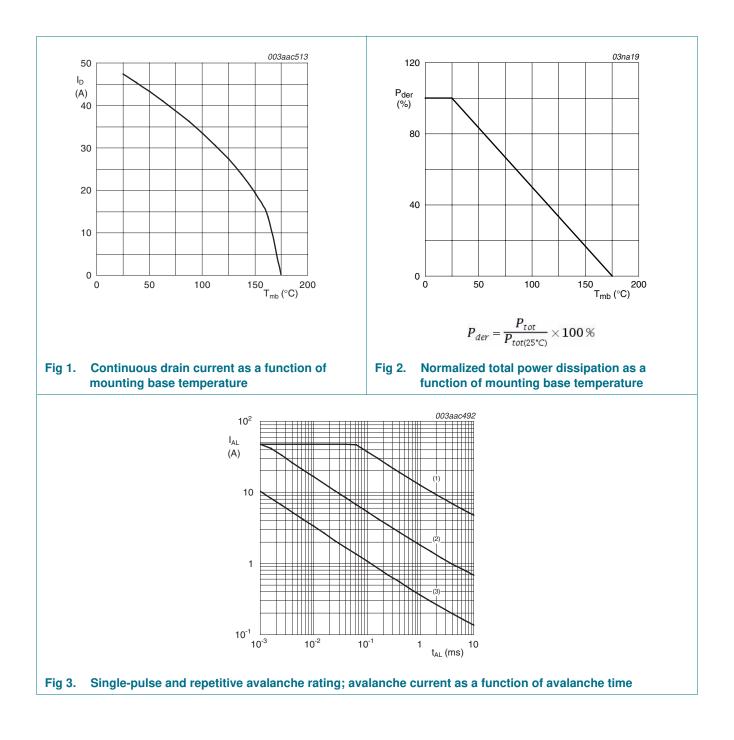
| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|----------------------|--|--|------------------|-----|-----|------|------|
| V _{DS} | drain-source voltage | T _j ≥ 25 °C; T _j ≤ 175 °C | | - | - | 55 | V |
| V _{DGR} | drain-gate voltage | $R_{GS} = 20 \text{ k}\Omega$ | | - | - | 55 | V |
| V _{GS} | gate-source voltage | | | -20 | - | 20 | V |
| I _D | drain current | $T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 1}}{\text{Figure 4}};$ | | - | - | 47.4 | A |
| | | T_{mb} = 100 °C; V_{GS} = 10 V; see Figure 1 | | - | - | 33.5 | А |
| I _{DM} | peak drain current | T _{mb} = 25 °C; t _p ≤ 10 μs; pulsed; see <u>Figure 4</u> | | - | - | 189 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; see <u>Figure 2</u> | | - | - | 85 | W |
| T _{stg} | storage temperature | | | -55 | - | 175 | °C |
| Tj | junction temperature | | | -55 | - | 175 | °C |
| Source-drai | in diode | | | | | | |
| I _S | source current | T _{mb} = 25 °C | | - | - | 47.4 | А |
| I _{SM} | peak source current | $t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$ | | - | - | 189 | А |
| Avalanche r | ruggedness | | | | | | |
| $E_{DS(AL)S}$ | non-repetitive drain-source avalanche energy | $\label{eq:ld} \begin{array}{l} I_D = 47.4 \text{ A}; \ V_{sup} \leq 55 \text{ V}; \ R_{GS} = 50 \ \Omega; \\ V_{GS} = 10 \text{ V}; \ T_{j(init)} = 25 \ ^\circ\text{C}; \ unclamped \end{array}$ | | - | - | 77 | mJ |
| E _{DS(AL)R} | repetitive drain-source avalanche energy | see Figure 3 | <u>[1][2][3]</u> | - | - | - | J |

[1] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[2] Repetitive avalanche rating limited by an average junction temperature of 170 °C.

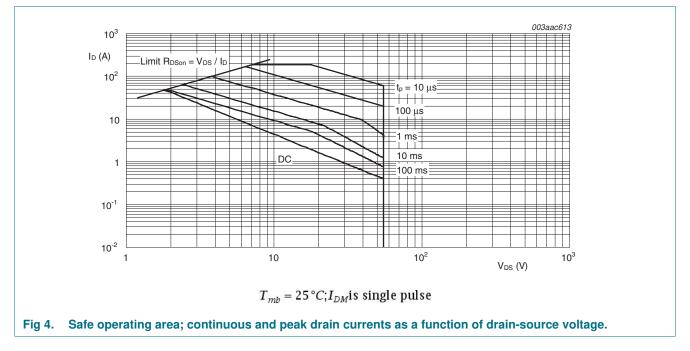
[3] Refer to application note AN10273 for further information.

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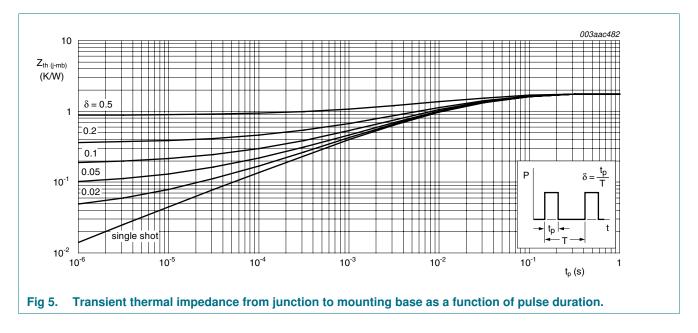
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5. Thermal characteristics

Table 5. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------|---|---------------------|-----|-----|------|------|
| $R_{th(j-mb)}$ | thermal resistance from junction to mounting base | see <u>Figure 5</u> | - | - | 1.76 | K/W |

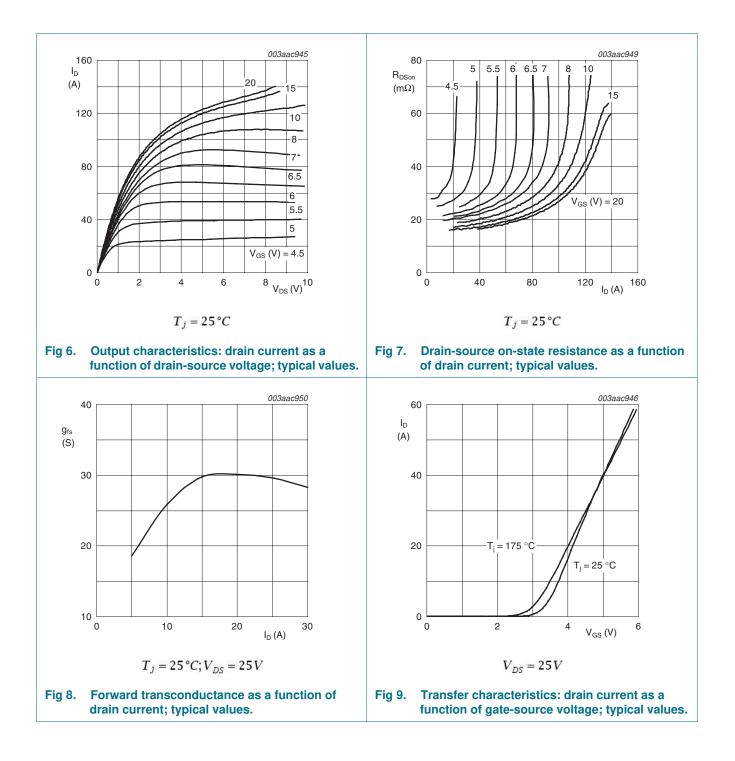


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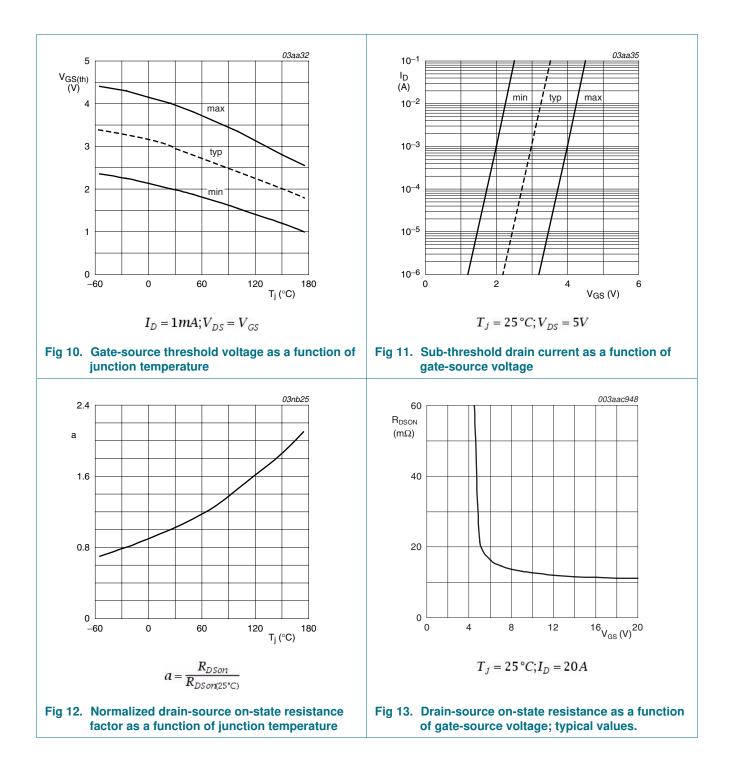
6. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------------------|-------------------------------------|---|-----|------|------|------|
| Static chara | cteristics | | | | | |
| V _{(BR)DSS} drain-source | | I _D = 250 μA; V _{GS} = 0 V; T _j = 25 °C | 55 | - | - | V |
| | breakdown voltage | $I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$ | 50 | - | - | V |
| V _{GS(th)} | gate-source threshold voltage | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 25 °C; see <u>Figure 10</u> ; see <u>Figure 11</u> | 2 | 3 | 4 | V |
| | | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 10</u> | - | - | 4.4 | V |
| | | I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; see <u>Figure 10</u> | 1 | - | - | V |
| DSS | drain leakage current | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$ | - | 0.02 | 1 | μA |
| | | $V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$ | - | - | 500 | μA |
| IGSS | gate leakage current | $V_{DS} = 0 V; V_{GS} = 20 V; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| | | $V_{DS} = 0 V; V_{GS} = -20 V; T_j = 25 \text{ °C}$ | - | 2 | 100 | nA |
| Doon | drain-source on-state resistance | V _{GS} = 10 V; I _D = 20 A; T _j = 175 °C; see <u>Figure 12</u> | - | - | 37.8 | mΩ |
| | | V_{GS} = 10 V; I_D = 20 A; T_j = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u> | - | 12.7 | 18 | mΩ |
| Dynamic ch | aracteristics | | | | | |
| Q _{G(tot)} | total gate charge | $I_D = 20 \text{ A}; V_{DS} = 44 \text{ V}; V_{GS} = 10 \text{ V};$ | - | 21.9 | - | nC |
| Q _{GS} | gate-source charge | see Figure 14 | - | 4.64 | - | nC |
| Q _{GD} | gate-drain charge | | - | 8.1 | - | nC |
| C _{iss} | input capacitance | $V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$ | - | 947 | 1263 | pF |
| C _{oss} | output capacitance | $T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 15}{15}$ | - | 223 | 268 | pF |
| C _{rss} | reverse transfer capacitance | | - | 105 | 144 | pF |
| d(on) | turn-on delay time | $V_{DS} = 30 \text{ V}; \text{ R}_{L} = 1.5 \Omega; \text{ V}_{GS} = 10 \text{ V};$ | - | 13 | - | ns |
| tr | rise time | $R_{G(ext)} = 10 \ \Omega$ | - | 20 | - | ns |
| t _{d(off)} | turn-off delay time | | - | 34 | - | ns |
| t _f | fall time | | - | 16 | - | ns |
| Source-drai | n diode | | | | | |
| V _{SD} | source-drain voltage | I _S = 20 A; V _{GS} = 25 V; T _j = 25 °C; see <u>Figure 16</u> | - | 0.85 | 1.2 | V |
| rr | reverse recovery time | $I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A}/\mu\text{s}; V_{GS} = 0 \text{ V};$ | - | 36 | - | ns |
| Q _r | recovered charge | $V_{DS} = 30 V$ | - | 55 | - | nC |

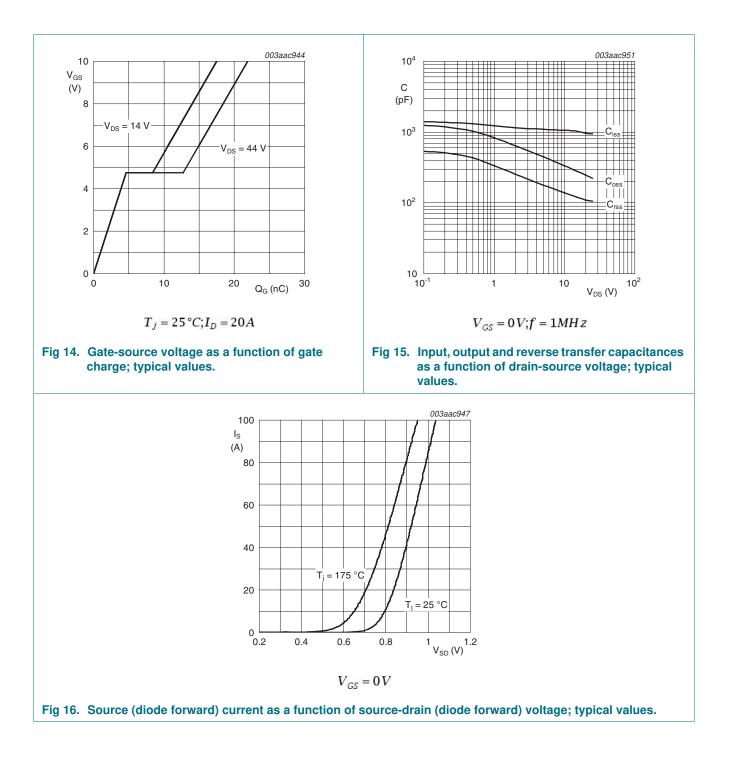
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7. Package outline

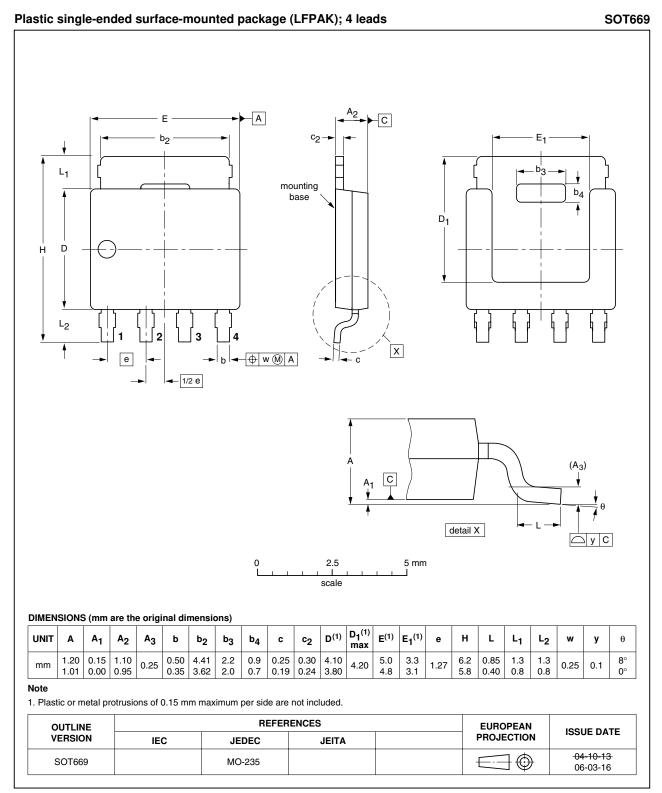


Fig 17. Package outline SOT669 (LFPAK)

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8. Revision history

| Table 7.Revision his | story | | | |
|----------------------|---------------------------------|-----------------------------|---------------|---------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| BUK7Y18-55B_4 | 20100407 | Product data sheet | - | BUK7Y18-55B_3 |
| Modifications: | Status char | nged from objective to proc | luct. | |
| BUK7Y18-55B_3 | 20100218 | Objective data sheet | - | BUK7Y18-55B_2 |

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9. Legal information

9.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nexperia.com</u>.

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